ROYALOHM

SPECIFICATION FOR APPROVAL

TRELIK

Description: Thick Film Chip Resistors (Terminal Lead Free)

Royalohm Part no.:

201007xxxxxT4E (RMC 3/4W-S (2010) +/-1%, 5% & Jumper)

| Approved by | | | | | |
|-------------|--|--|--|--|--|
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Parts corresponding to RoHS Compliant: 2005-Apr.-1

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| Approved | Checked | Prepared |
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| Mr. Jack Lin | Mr. S. Polthanasan | Ms. P. Supatta |

Issue Date: 2015/01/10

| | CHANGE NOTIFICATION HISTORY | | | | | | | |
|---------|-----------------------------|--|--|--|--|--|--|--|
| Version | Date of Version | Remark | | | | | | |
| 1 | 2015/01/10 | 1. Chip series (2010) @ 3/4W-S | | | | | | |
| | | 2. Resistance tolerance: ±1%, ±5% & Jumper | | | | | | |
| | | 3. Temperature coefficient 1Ω - 10Ω : ± 400 PPM/°C | | | | | | |
| | | 11Ω-100Ω : ± 200 PPM/°C | | | | | | |
| | | >100Ω: ±100 PPM/°C | | | | | | |
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Customer: TRELIK Part. No.: 201007xxxxxT4E

1. Scope:

This specification for approval relates to Thick Film Chip Resistors (Terminal Lead Free) manufactured by ROYALOHM 's specifications.

2. Type designation:

The type designation shall be in the following form:

Ex.

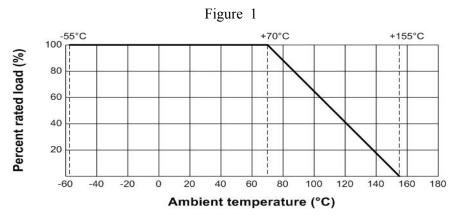
| Type | Power Rating Resistance tolerance | | Nominal Resistance | |
|----------|-----------------------------------|------|--------------------|--|
| RMC 2010 | 0.75W (3/4W-S) | F, J | 1ΚΩ | |

3. Ratings:

| Туре | RMC 2010 |
|---------------------------------|----------------|
| Power Rating | 0.75W (3/4W-S) |
| Rated Current (Jumper) | 2A |
| Max. Overload Current (Jumper) | 10A |
| Max. Working Voltage | 200 V |
| Max. Overload Voltage | 500 V |
| Dielectric Withstanding Voltage | 500 V |
| Temperature Range | -55°C ~ +155°C |
| Ambient Temperature | 70 ℃ |

3.1 Power rating:

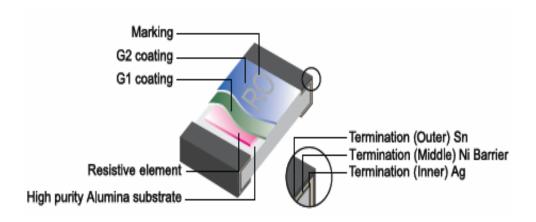
Resistors shall have a power rating based on continuous load operation at an ambient temperature of 70 $^\circ\! C$. For temperature in excess of 70 $^\circ\! C$, The load shall be derate as shown in figure 1.



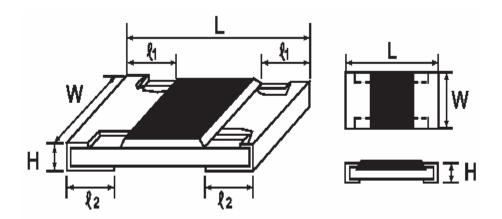
3.2 Nominal Resistance

Effective figures of nominal resistance shall be in accordance with E-24 and E-96 series. E-96 series for 1% and E-24 series for 2%, 5%.

4. Construction:



5. Power rating and dimensions



Dimension:

| | | | Dimension (mm) | | |
|----------|--------------|--------------|----------------|----------|-------------------|
| Туре | $L \pm 0.10$ | $W \pm 0.15$ | $H \pm 0.10$ | ℓ1± 0.25 | $\ell 2 \pm 0.20$ |
| RMC 2010 | 5.00 | 2.50 | 0.55 | 0.60 | 0.50 |

Power Rating:

| Туре | Power Rating | Tolerance | Resistance | Standard |
|----------|--------------|-----------|---------------------------|----------|
| 31 | at 70 ℃ | % | Range | Series |
| | | Jumper | $< 50 \mathrm{m}\Omega$ | |
| RMC 2010 | 3/4W-S | ± 1 | $10\Omega\sim 1M\Omega$ | E-96 |
| | | ± 5 | $1\Omega \sim 10 M\Omega$ | E-24 |

6. Marking:

6.1 Resistors

A. Marking for E-96 series in 2010 size: 4 Digits

*The first 3 digits are singnificant figures of resistance and the 4th digit denoted number of zeros.

Ex. 1003 100K Ω

*For ohmic values below 100 Ω , letter"R" is for decimal point.

Ex. 1R80 1.8Ω

B. Marking for E-24 series in 2010 size: 3 Digits

*The first 2 digits are singnificant figures of resistance and the 3rd digit denoted number of zeros.

Ex. 102 1KΩ

*For ohmic values below 10 Ω , letter"R" is for decimal point.

Ex. R68 0.68 Ω

6.2 Labels

Label shall be marked with the following item:

- A. Nominal Resistance and Resistance Tolerance
- B. Power Rating and Size
- C. Quantity
- D. Part No.
- E. P.O.No.
- F. Lot No.

Ex.

| ROYALOHM Chip Resistors | | | | | | |
|-------------------------|--------|------|-------------|--|--|--|
| Resistance: | 1K | Ω | ± 5% | | | |
| Wattage: | 3/4W-S | 5 | Size : 2010 | | | |
| Quantity: | 4000 P | es. | PPM | | | |
| Part No.: | | | | | | |
| Lot No.: | 825723 | 2010 | 07J0102T4E | | | |
| | | | | | | |

Remark: Label is 1K, value is $1K\Omega$, marking is 102

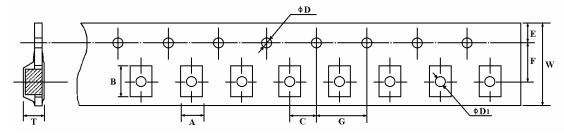
| Thick Film Chip Resistors (Terminal Lead Free) | | | | | | |
|--|---|--|--|--|--|--|
| 7. Performano | ce specification : | | | | | |
| Characteristics | Limits | Test Methods (JIS C 5201-1) | | | | |
| *Insulation resistance | 1,000 M Ω or more | Apply 500V DC between protective coating and termination for 1 min, then measure (Sub-clause 4.6) | | | | |
| *Dielectric withstanding voltage | No evidence of flashover mechanical damage, arcing or insulation break down | Apply 500V AC between protective coating and termination for 1 minute (Sub-clause 4.7) Natural resistance change per temp. | | | | |
| Temperature coefficient | 1Ω -10Ω: ± 400 PPM/°C 11Ω -100Ω: ± 200 PPM/°C >100Ω: ± 100 PPM/°C | degree centigrade. R2-R1 x 10 ⁶ (PPM/°C) R1(t2-t1) R1: Resistance value at room temperature (t1) R2: Resistance value at room temp. plus 100 °C (t2) (Sub-clause 4.8) | | | | |
| Short time overload | Resistance change rate is $\pm 5\% (2.0\% + 0.1 \Omega)$ Max. $\pm 1\% (1.0\% + 0.1 \Omega)$ Max. | Permanent resistance change after the application of a potential of 2.5 times RCWV for 5 seconds (Sub-clause 4.13) | | | | |
| *Solderability | 95 % coverage Min. | Test temperature of solder: 245 ± 3°C Dipping them solder: 2-3 seconds (Sub-clause 4.17) | | | | |
| Soldering temp. reference | Electrical characteristics shall be satisfied. Without distinct deformation in appearance. (95 % coverage Min.) | Wave soldering condition: (2 cycles Max.) Pre-heat: 100 ~ 120 °C, 30 ± 5 sec. Suggestion solder temp.: 235 ~ 255 °C, 10 sec. (Max.) Peak temp.: 260 °C Reflow soldering condition: (2 cycles Max.) Pre-heat: 150 ~ 180 °C, 90 ~ 120 sec. Suggestion solder temp.: 235 ~ 255 °C, 20 ~ 40 sec. Peak temp.: 260 °C Peak: 260 °C Peak: 260 °C Peak: 260 °C Peak: 255 °C, 20 ~ 40 sec. Peak temp.: 260 °C Peak: 255 °C, 20 ~ 40 sec. Peak temp.: 260 °C Peak: 260 °C | | | | |
| | | 300°C and maximum contract time should be 5 sec. | | | | |

| | Thick Film Chip Resi | stors (Term | inal Lead Free) | | | |
|-----------------|--------------------------------------|--|--------------------------|---------------------------------------|--|--|
| 7. Performano | ce specification: | | | | | |
| Characteristics | Limits | Test Methods | | | | |
| Characteristics | Limits | (JIS C 5201-1) | | | | |
| Soldering | Resistance change rate is: | Dip the resist | tor into a solder bath h | naving | | |
| Heat | $\pm (1\% + 0.05\Omega)$ Max. | a temperature | e of 260°C±3°C and h | old it for 10±1 | | |
| | | seconds. | | | | |
| | | (Sub-clause 4 | 4.18) | | | |
| | | Resistance cl | nange after continuous | 3 | | |
| | | 5 cycles for o | duty cycle specified be | elow: | | |
| | Resistance change rate is | Step | Temperature | Time | | |
| Temperature | $\pm 5\% (1.0\% + 0.05 \Omega)$ Max. | 1 | -55°C ± 3°C | 30 mins | | |
| cycling | $\pm 1\% (0.5\% + 0.05 \Omega)$ Max. | 2 | Room temp. | 10~15 mins | | |
| | | 3 | +155°C ± 2°C | 30 mins | | |
| | | 4 | Room temp. | 10~15 mins | | |
| | | (Sub-clause 4 | 4.19) | | | |
| | | Resistance cl | nange after 1,000 hour | S | | |
| Load life in | Resistance change rate is | (1.5 hours "o | n", 0.5 hour "off") at | RCWV | | |
| humidity | $\pm 5\% (3.0\% + 0.1 \Omega)$ Max. | in a humidity | chamber controlled a | t | | |
| | $\pm 1\% (1.0\% + 0.1 \Omega)$ Max. | $40^{\circ}\text{C} \pm 2^{\circ}\text{C}$ a | and 90 to 95 % relative | humidity | | |
| | | (Sub-clause 4 | 4.24.2.1) | | | |
| | Resistance change rate is | Permanent re | esistance change after | 1,000 hours | | |
| Load Life | $\pm 5\% (3.0\% + 0.1 \Omega)$ Max. | operating at l | RCWV, with duty cyc | le of | | |
| | $\pm 1\% (1.0\% + 0.1 \Omega)$ Max. | (1.5 hours"or | n", 0.5 hour"off") at 70 | 0° C ± 2° C ambient | | |
| | | (Sub-clause 4 | 4.25.1) | | | |
| Terminal | Resistance change rate is | Twist of Test | t Board : | | | |
| bending | $\pm (1.0\% + 0.05 \Omega)$ Max. | Y/X = 5/90 n | nm for 10 seconds | | | |
| | | (Sub-clause 4 | 4.33) | | | |

The resistors of 0Ω only can do the characteristic noted of *

8. Packing specification:

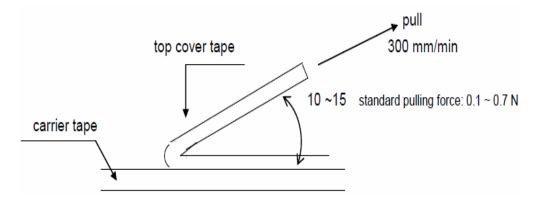
* Taping Dimension (mm)



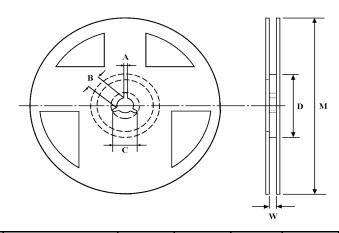
| Туре | A ±0.2 | B ±0.2 | C ±0.05 | φ D+0.1 -0 | E ±0.1 | F ±0.05 | G ±0.1 | W ±0.2 | φ D1+0.1 -0 | $T \pm 0.1$ |
|------|--------|--------|---------|---------------|--------|---------|--------|--------|----------------|-------------|
| 2010 | 2.9 | 5.6 | 2.0 | 1.5 | 1.75 | | 4.0 | 12 | 1.5 | 1.0 |

* Peeling Strength of Top Cover Tape

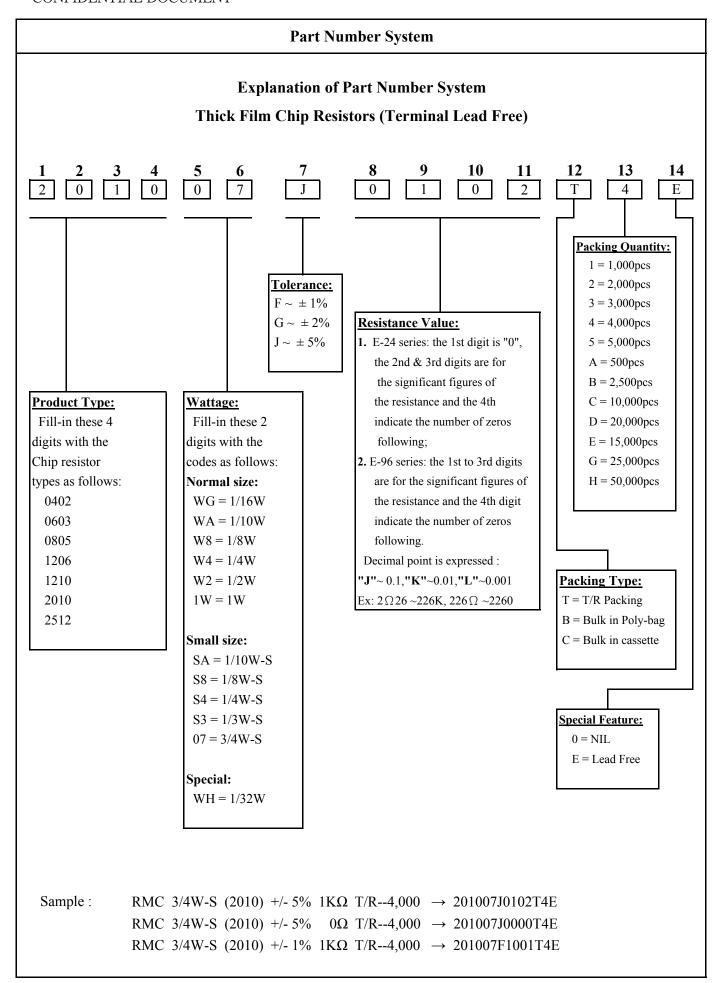
Test Condition: 0.1 to 0.7 N at a peel-off speed of 300 mm / min.



* Reel Dimension (mm)



| Туре | Quantity Per Reel | $A \pm 0.5$ | $B \pm 0.5$ | $C \pm 0.5$ | D ± 1 | $M \pm 2$ | W ± 1 |
|------|-------------------|-------------|-------------|-------------|-------|-----------|-------|
| 2010 | 4000 Pcs. Reel | 2 | 13 | 21 | 60 | 178 | 13.8 |



Environment Related Substance

This product complies to EU RoHS directive, EU PAHs directive, EU PFOS directive and Halogen free.

Ozone layer depleting substances.

Ozone depleting substances are not used in our manufacturing process of this product.

This product is not manufactured using Chloro fluorocarbons (CFCs), Hydrochlorofluorocarbons (HCFCs),

Hydrobromofluorocarbons (HBFCs) or other ozone depleting substances in any phase of the manufacturing process.

Storage Condition

The performance of these products, including the solderability, is guaranteed for a year from the date of arrival at your company, provided that they remain packed as they were when delivered and stored at a temperature of $25^{\circ}\text{C} \pm 5^{\circ}\text{C}$ and a relative humidity of $60\%\text{RH} \pm 10\%\text{RH}$

Even within the above guarantee periods, do not store these products in the following conditions. Otherwise, their electrical performance and/or solderability may be deteriorated, and the packaging materials (e.g. taping materials) may be deformed or deteriorated, resulting in mounting failures.

- 1. In salty air or in air with a high concentration of corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NO₂
- 2. In direct sunlight